	2001/10/16	USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM	257/734.ccls.	60 60	L41	BRS	12
	2001/10/16 19:23	USPAT; US-PGPU B; EPO; JPO; DERWENT; IBM TDB	257/738.ccls.	641	L40	BRS	}
	2001/10/16		L38 and semiconductor	60	L39	BRS	10
	2001/10/16	H * G	(solder with (metal adj ball))	100	L38	BRS	0
	2001/10/16	m '' L	257/\$.ccls and (solder with (metal adj ball))	O N	L37	BRS	∞ .
	2001/10/16	H 'C	(semiconductor adj device) and (terminal with (metal adj ball))	31	L36	BRS	7
	2001/10/16 18:44	1	"5994212".PN.	<u>-</u>	L35	BRS	Q
	2001/10/16 18:44	USPAT	"5994152".PN.	<u>-</u>	L34	BRS	Ŋ
	2001/10/16 18:44	USPAT	"5686353".PN.	-	L33	BRS	,42
	2001/10/16 18:43	USPAT	"5633204".PN.	⊢	L32	BRS	ω
	2001/10/16 18:43	USPAT	5124277".PN.	₽ =	L31	BRS	2
	2001/10/16 18:58	USPAT	"6284640").PN.		.,		ㅂ
p Comments Error	Time Stamp	DBs	Search Text	Hits	#	Туре	
Comments	Time Stam 2001/10/16 18:58 2001/10/16			ch Text	Hits Search Text ("6284640").PN.	# Hits Search Text 1 ("6284640").PN.	Ype L # Hits Search Text R L30 1 ("6284640").PN.

	Туре	#	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition
13 B	BRS	L42	116	L40 and (metal with ball)	USPAT; US-PGPU B; EPO; JPO; DERWENT; IBM	USPAT; US-PGPU US-PGPU 19:2001/10/16 JPO; DERWENT 19:23 ; IBM TDB		
1.1 4.2 W	BRS	L43	10	L41 and (metal with ball)	USPAT; US-PGPU B; EPO; JPO; DERWENT; IBM	USPAT; US-PGPU US-PGPU B; EPO; 2001/10/16 JPO; 19:23 DERWENT 19:23 ; IBM TDB		
15 B	BRS	L44	60	semiconductor and (terminal same (metal adj ball))	USPAT; US-PGPU B; EPO; JPO; DERWENT; IBM	USPAT; US-PGPU B; EPO; 2001/10/16 JPO; DERWENT 19:31 ; IBM		*
16 E	BRS	L45	 3	(internal with terminal) with (metal adj ball)	USPAT; US-PGPU B; EPO; JPO; DERWENT; IBM TDB	USPAT; US-PGPU B; EPO; 2001/10/16 JPO; DERWENT 19:31 ; IBM TDB		